2-input Exclusive-OR Gate

HITACHI

ADE-205-608B (Z)

Rev.2 Aug. 2001

Description

The HD74ALVC1G86 performs the Boolean functions $Y = A \oplus B$ or $Y = \overline{AB} + A\overline{B}$ in positive logic. A common application is as a true / complement element. If one of the inputs is low, the other input will be reproduced in true form at the output. If one of the inputs is high, the signal on the other input will be reproduced inverted form at the output. Low voltage and high speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

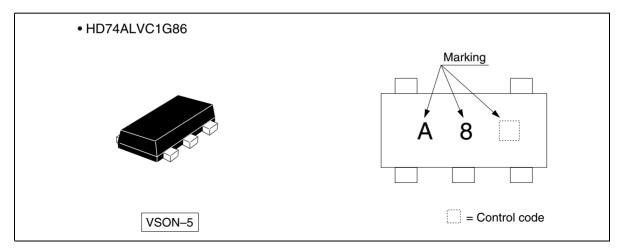
Features

- The basic gate function is lined up as hitachi uni logic series.
- Supplied on emboss taping for high speed automatic mounting.
- Supply voltage range : 1.2 to 3.6 V Operating temperature range : -40 to +85°C
- All inputs V_{H} (Max.) = 3.6 V (@V_{cc} = 0 V to 3.6 V) All outputs V_{0} (Max.) = 3.6 V (@V_{cc} = 0 V)
- Output current $\pm 2 \text{ mA} (@V_{cc} = 1.2 \text{ V})$ $\pm 4 \text{ mA} (@V_{cc} = 1.4 \text{ V} \text{ to } 1.6 \text{ V})$ $\pm 6 \text{ mA} (@V_{cc} = 1.65 \text{ V} \text{ to } 1.95 \text{ V})$ $\pm 18 \text{ mA} (@V_{cc} = 2.3 \text{ V} \text{ to } 2.7 \text{ V})$ $\pm 24 \text{ mA} (@V_{cc} = 3.0 \text{ V} \text{ to } 3.6 \text{ V})$
- Package type

Package type	Package code	Package suffix	Taping code
VSON-5 pin	TNP-5D	VS	E (3,000 pcs / Reel)



Outline and Article Indication



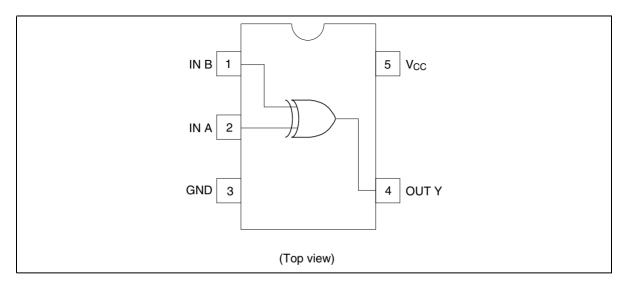
Function Table

Inputs		Output Y		
Α	В			
L	L	L		
L	Н	Н		
Н	L	Н		
Н	Н	L		

H : High level

L : Low level

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{cc}	-0.5 to 4.6	V	
Input voltage range ^{*1}	V	-0.5 to 4.6	V	
Output voltage range *1, 2	Vo	–0.5 to V _{cc} + 0.5	V	Output : H or L
		-0.5 to 4.6		V _{cc} : OFF
Input clamp current	Ι _{ικ}	-50	mA	V ₁ < 0
Output clamp current	I _{ок}	±50	mA	V_{o} < 0 or V_{o} > V_{cc}
Continuous output current	I _o	±50	mA	$V_{o} = 0$ to V_{cc}
Continuous current through V_{cc} or GND	$I_{\rm cc}$ or $I_{\rm gnd}$	±100	mA	
Maximum power dissipation at Ta = 25°C (in still air) 3	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. This value is limited to 4.6 V maximum.

3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Item	Symbol	Min	Мах	Unit	Conditions
Supply voltage range	V _{cc}	1.2	3.6	V	
Input voltage range	V,	0	3.6	V	
Output voltage range	V _o	0	V _{cc}	V	
Output current	I _{oh}		-2	mA	V _{cc} = 1.2 V
			-4		V _{cc} = 1.4 V
			-6		V _{cc} = 1.65 V
			-18		V _{cc} = 2.3 V
			-24		V _{cc} = 3.0 V
	I _{ol}		2		V _{cc} = 1.2 V
			4		V _{cc} = 1.4 V
			6		V _{cc} = 1.65 V
			18		V _{cc} = 2.3 V
		_	24		V _{cc} = 3.0 V
Input transition rise or fall rate	Δt / Δv	0	20	ns / V	V_{cc} = 1.2 to 2.7 V
		0	10		V _{cc} = 3.3±0.3 V
Operating free-air temperature	T _a	-40	85	°C	

Recommended Operating Conditions

Note: Unused or floating inputs must be held high or low.

Electrical Characteristic

• Ta = -40 to $85^{\circ}C$

Item	Symbol	V_{cc} (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V	1.2	V _{cc} ×0.75	_	_	V	
		1.4 to 1.6	V _{cc} ×0.7	_	_	_	
		1.65 to 1.95	V _{cc} ×0.7	—	_	_	
		2.3 to 2.7	1.7	_	—	_	
		3.0 to 3.6	2.0	_	_		
	V	1.2	_	_	V _{cc} ×0.25	-	
		1.4 to 1.6	_	_	V _{cc} ×0.3	-	
		1.65 to 1.95	_	_	V _{cc} ×0.3	-	
		2.3 to 2.7	_	_	0.7	-	
		3.0 to 3.6	_	_	0.8	-	
Output voltage	V _{OH}	Min to Max	V _{cc} -0.2	_	—	V	I _{oH} = −100 μA
		1.2	0.9	_	—	-	I _{он} = –2 mA
		1.4	1.1	_	—	_	I _{он} = -4 mA
		1.65	1.2	_	—	-	I _{он} = –6 mA
		2.3	1.7	_	—	-	I _{он} = –18 mA
		3.0	2.2	_	_	_	I _{он} = –24 mA
	V _{ol}	Min to Max	_	_	0.2		I _{oL} = 100 μA
		1.2	_	_	0.3		I _{oL} = 2 mA
		1.4	_	_	0.3	-	$I_{oL} = 4 \text{ mA}$
		1.65	_	_	0.3	-	I _{oL} = 6 mA
		2.3	_	_	0.55	-	I _{oL} = 18 mA
		3.0	_	_	0.55	-	I _{oL} = 24 mA
Input current	I _{IN}	3.6	—	_	±5	μA	$V_{IN} = 3.6 \text{ V or GND}$
Quiescent supply current	I _{cc}	3.6	—	_	10	μA	$V_{IN} = V_{CC}$ or GND, $I_{O} = 0$
Output leakage current	I _{off}	0	_	_	5	μA	V_1 or $V_0 = 0$ to 3.6 V
Input capacitance	C	3.3	_	2.5	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

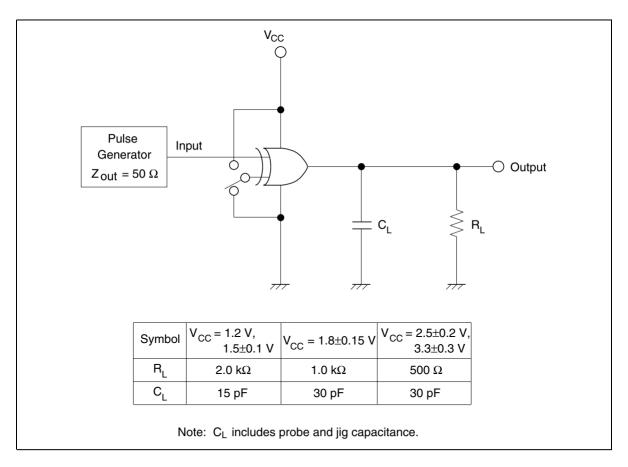
• $V_{cc} = 1.2 V$

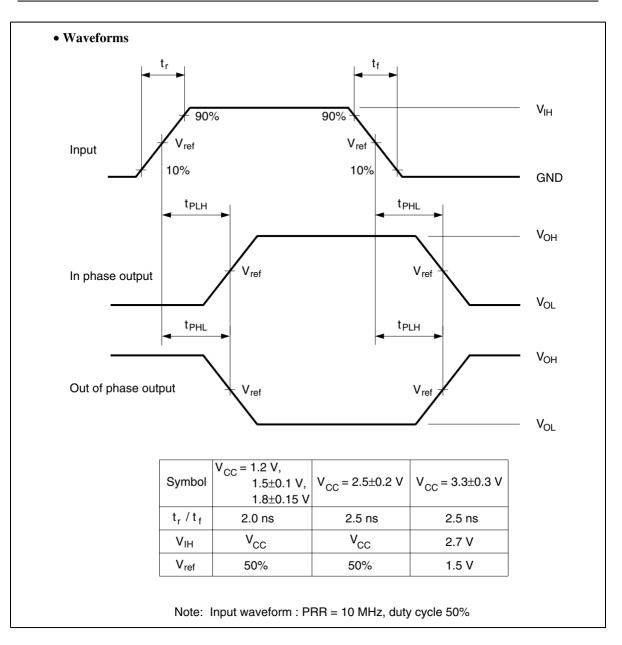
Item	Symbol	Ta = -40 to 85°C		Unit	Test	FROM	то	
		Min	Тур	Max		Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	—	7.5	—	ns	C _L = 15 pF	A or B	Y
• $V_{cc} = 1.5 \pm 0.1 \text{ V}$								
Item	Symbol	Ta = -40 to 85°C		Unit	Test	FROM	то	
		Min	Тур	Max		Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	2.0	_	8.0	ns	$C_{L} = 15 \text{ pF}$	A or B	Y
• $V_{cc} = 1.8 \pm 0.15 V$								
Item	Symbol	Ta = -40 to 85°C		Unit	Test	FROM	то	
		Min	Тур	Мах		Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.5	_	6.0	ns	$C_{L} = 30 \text{ pF}$	A or B	Y
• $V_{cc} = 2.5 \pm 0.2 V$								
Item	Symbol	Ta = –40 to 85°C		Unit	Test	FROM	то	
		Min	Тур	Max		Conditions		(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.0	—	4.0	ns	$C_{L} = 30 \text{ pF}$	A or B	Y
• $V_{cc} = 3.3 \pm 0.3 \text{ V}$								
Item	Symbol	Ta = –40 to 85°C		Unit	Test	FROM	то	
		Min	Тур	Max		Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.0		3.0	ns	$C_{L} = 30 \text{ pF}$	A or B	Y

Operating Characteristics

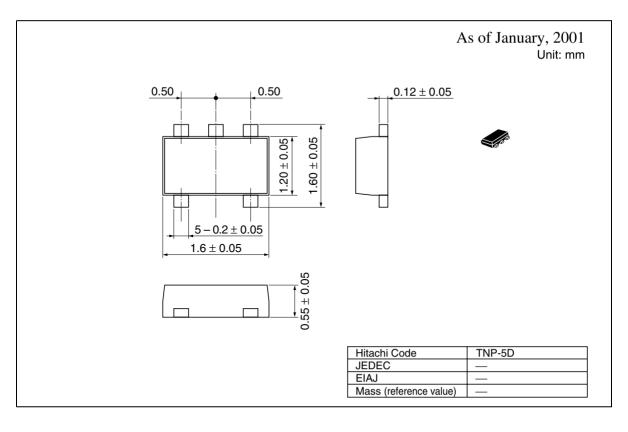
Item	Symbol	V _{cc} (V)	Ta = 2	Ta = 25°C			Test Conditions
			Min	Тур	Max		
Power dissipation	C _{PD}	1.5	_	10.5		pF	f = 10 MHz
capacitance		1.8	—	10.5	_		
		2.5	_	10.5			
		3.3	—	11.5			

Test Circuit





Package Dimensions



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